74LVC1G53

2-channel analog multiplexer/demultiplexer Rev. 8 — 22 June 2012

Product data sheet

General description 1.

The 74LVC1G53 is a low-power, low-voltage, high-speed, Si-gate CMOS device.

The 74LVC1G53 provides one analog multiplexer/demultiplexer with a digital select input (S), two independent inputs/outputs (Y0 and Y1), a common input/output (Z) and an active LOW enable input (E). When pin E is HIGH, the switch is turned off.

Schmitt trigger action at the select and enable inputs makes the circuit tolerant of slower input rise and fall times across the entire V_{CC} range from 1.65 V to 5.5 V.

Features and benefits 2.

- Wide supply voltage range from 1.65 V to 5.5 V
- Very low ON resistance:
 - 7.5 Ω (typical) at $V_{CC} = 2.7 \text{ V}$
 - 6.5 Ω (typical) at $V_{CC} = 3.3 \text{ V}$
 - 6 Ω (typical) at $V_{CC} = 5 \text{ V}$
- Switch current capability of 32 mA
- High noise immunity
- CMOS low power consumption
- TTL interface compatibility at 3.3 V
- Latch-up performance meets requirements of JESD 78 Class I
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Control inputs accept voltages up to 5 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C



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3. Ordering information

Table 1. Ordering information

Type number	Package								
	Temperature range	Name	Description	Version					
74LVC1G53DP	-40 °C to +125 °C	TSSOP8	plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm	SOT505-2					
74LVC1G53DC	–40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads; body width 2.3 mm	SOT765-1					
74LVC1G53GT	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 1 \times 1.95 \times 0.5 mm	SOT833-1					
74LVC1G53GF	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body $1.35 \times 1 \times 0.5$ mm	SOT1089					
74LVC1G53GD	–40 °C to +125 °C	XSON8U	plastic extremely thin small outline package; no leads; 8 terminals; UTLP based; body $3\times2\times0.5$ mm	SOT996-2					
74LVC1G53GM	–40 °C to +125 °C	XQFN8	plastic, extremely thin quad flat package; no leads; 8 terminals; body $1.6 \times 1.6 \times 0.5$ mm	SOT902-2					
74LVC1G53GN	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body $1.2 \times 1.0 \times 0.35$ mm	SOT1116					
74LVC1G53GS	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body $1.35 \times 1.0 \times 0.35$ mm	SOT1203					

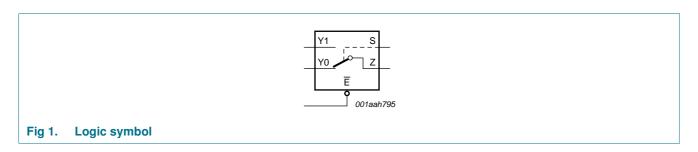
4. Marking

Table 2. Marking codes

Type number	Marking code ^[1]
74LVC1G53DC	V53
74LVC1G53DP	V53
74LVC1G53GT	V53
74LVC1G53GF	V3
74LVC1G53GD	V53
74LVC1G53GM	V53
74LVC1G53GN	V3
74LVC1G53GS	V3

^[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

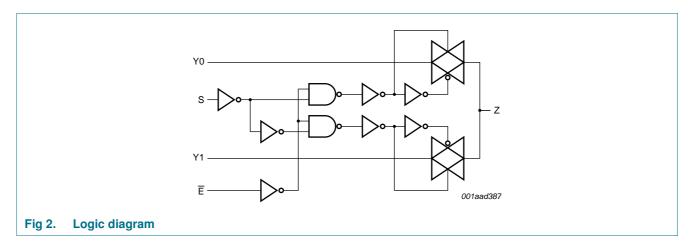
5. Functional diagram



74LVC1G53

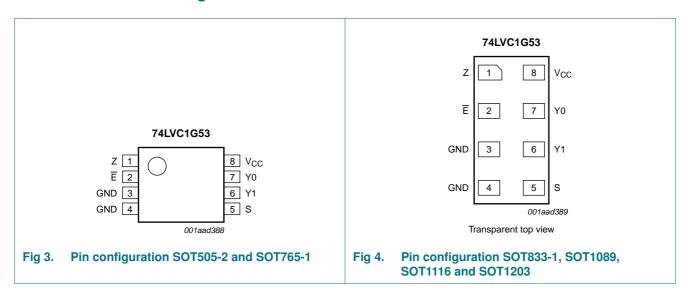
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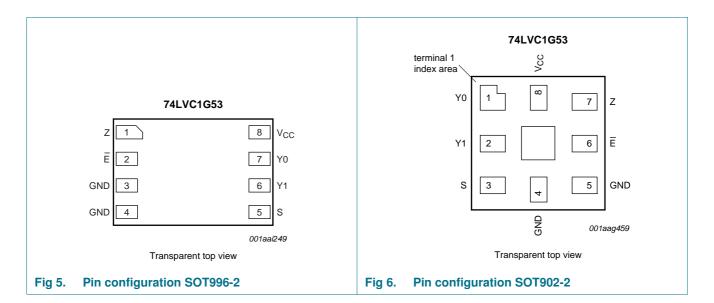


6. Pinning information

6.1 Pinning



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6.2 Pin description

Table 3. Pin description

Symbol	Pin		Description
	SOT505-2, SOT765-1, SOT833-1, SOT1089, SOT996-2, SOT1116 and SOT1203	SOT902-2	_
Z	1	7	common output or input
Ē	2	6	enable input (active LOW)
GND	3	5	ground (0 V)
GND	4	4	ground (0 V)
S	5	3	select input
Y1	6	2	independent input or output
Y0	7	1	independent input or output
V_{CC}	8	8	supply voltage

7. Functional description

Table 4. Function table[1]

Input		Channel on
S	E	
L	L	Y0 to Z or Z to Y0
Н	L	Y1 to Z or Z to Y1
Х	Н	Z (switch off)

^[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

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8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+6.5	V
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{IK}	input clamping current	$V_I < -0.5 \text{ V or } V_I > V_{CC} + 0.5 \text{ V}$	-50	-	mA
I _{SK}	switch clamping current	$V_I < -0.5 \text{ V or } V_I > V_{CC} + 0.5 \text{ V}$	-	±50	mA
V _{SW}	switch voltage	enable and disable mode	<u>[2]</u> –0.5	$V_{CC} + 0.5$	V
I _{SW}	switch current	$V_{SW} > -0.5 \ V$ or $V_{SW} < V_{CC} + 0.5 \ V$	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	[3] _	250	mW

^[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

9. Recommended operating conditions

Table 6. Operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		1.65	5.5	V
VI	input voltage		0	5.5	V
V_{SW}	switch voltage	enable and disable mode	[1] 0	V_{CC}	V
T _{amb}	ambient temperature		-40	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 1.65 \text{ V to } 2.7 \text{ V}$	[2] _	20	ns/V
		$V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$	[2] _	10	ns/V

^[1] To avoid sinking GND current from terminal Z when switch current flows in terminal Yn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no GND current will flow from terminal Yn. In this case, there is no limit for the voltage drop across the switch.

^[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed.

^[3] For TSSOP8 packages: above 55 °C the value of P_{tot} derates linearly with 2.5 mW/K.

For VSSOP8 packages: above 110 °C the value of P_{tot} derates linearly with 8.0 mW/K.

For XSON8, XSON8U and XQFN8 packages: above 118 °C the value of P_{tot} derates linearly with 7.8 mW/K.

^[2] Applies to control signal levels.

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10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

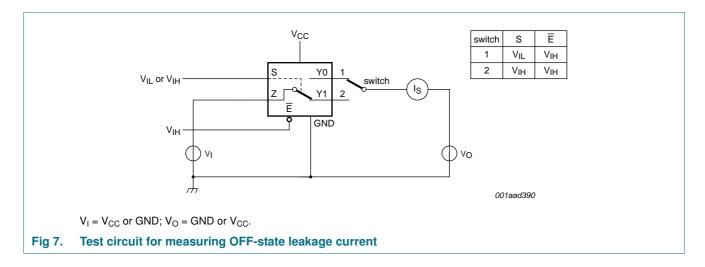
Parameter	eter Conditions		$T_{amb} = -$	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$			$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$		
			Min	Typ[1]	Max	Min	Max		
HIGH-level	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V	
input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.7	-	-	1.7	-	٧	
	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$		2.0	-	-	2.0	-	٧	
	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		$0.7 \times V_{CC}$	-	-	$0.7 \times V_{CC}$	-	٧	
LOW-level	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{\text{CC}}$	V	
input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	-	0.7	-	0.7	V	
	$V_{CC} = 3 \text{ V to } 3.6 \text{ V}$		-	-	0.8	-	0.8	٧	
	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		-	-	$0.3\times V_{\text{CC}}$	-	$0.3 \times V_{\text{CC}}$	V	
input leakage current	pin S and pin \overline{E} ; $V_1 = 5.5 \text{ V or GND}$; $V_{CC} = 0 \text{ V to } 5.5 \text{ V}$	[2]	-	±0.1	±2	-	±10	μΑ	
OFF-state leakage current	V _{CC} = 5.5 V; see <u>Figure 7</u>	[2]	-	±0.1	±5	-	±20	μΑ	
ON-state leakage current	V _{CC} = 5.5 V; see <u>Figure 8</u>	[2]	-	±0.1	±5	-	±20	μΑ	
supply current	V_I = 5.5 V or GND; V_{SW} = GND or V_{CC} ; V_{CC} = 1.65 V to 5.5 V	[2]	-	0.1	10	-	40	μΑ	
additional supply current	pin S and pin \overline{E} ; $V_I = V_{CC} - 0.6 \text{ V}$; $V_{SW} = \text{GND or } V_{CC}$; $V_{CC} = 5.5 \text{ V}$	<u>[2]</u>	-	5	500	-	5000	μА	
input capacitance			-	2.5	-	-	-	pF	
OFF-state capacitance			-	6.0	-	-	-	pF	
ON-state capacitance			-	18	-	-	-	pF	
	input voltage LOW-level input voltage input leakage current OFF-state leakage current ON-state leakage current supply current additional supply current input capacitance OFF-state capacitance ON-state		$ \begin{array}{c} \text{input voltage} \\ \hline \\ V_{CC} = 2.3 \ \text{V to } 2.7 \ \text{V} \\ \hline \\ V_{CC} = 3 \ \text{V to } 5.5 \ \text{V} \\ \hline \\ V_{CC} = 4.5 \ \text{V to } 5.5 \ \text{V} \\ \hline \\ V_{CC} = 1.65 \ \text{V to } 1.95 \ \text{V} \\ \hline \\ V_{CC} = 2.3 \ \text{V to } 2.7 \ \text{V} \\ \hline \\ V_{CC} = 3 \ \text{V to } 5.5 \ \text{V} \\ \hline \\ V_{CC} = 3 \ \text{V to } 5.5 \ \text{V} \\ \hline \\ \text{input leakage} \\ \text{current} \\ \hline \\ V_{I} = 5.5 \ \text{V or GND}; \\ \hline \\ V_{CC} = 0 \ \text{V to } 5.5 \ \text{V} \\ \hline \\ \text{OFF-state} \\ \text{leakage} \\ \text{current} \\ \hline \\ \hline \\ ON\text{-state} \\ \text{leakage} \\ \text{current} \\ \hline \\ \hline \\ \text{Supply current} \\ \hline \\ V_{I} = 5.5 \ \text{V or GND}; \\ \hline \\ V_{SW} = GND \ \text{or } V_{CC}; \\ \hline \\ V_{CC} = 1.65 \ \text{V to } 5.5 \ \text{V} \\ \hline \\ \text{additional} \\ \text{supply current} \\ \hline \\ \text{supply current} \\ \hline \\ \hline \\ V_{I} = V_{CC} - 0.6 \ \text{V}; \\ \hline \\ V_{SW} = GND \ \text{or } V_{CC}; \\ \hline \\ V_{CC} = 5.5 \ \text{V} \\ \hline \\ \text{input} \\ \hline \\ \text{capacitance} \\ \hline \\ \hline \\ \text{ON-state} \\ \hline \\ \hline \\ \text{OFF-state} \\ \hline \\ \text{capacitance} \\ \hline \\ \hline \\ \text{ON-state} \\ \hline \\ \hline \\ \hline \\ \text{ON-state} \\ \hline \\ \hline \\ \text{ON-state} \\ \hline \\ \hline \\ \hline \\ \text{ON-state} \\ \hline \\ \hline \\ \hline \\ \hline \\ \text{ON-state} \\ \hline \\ \hline \\ \hline \\ \text{ON-state} \\ \hline \\ \hline \\ \hline \\ \hline \\ \hline \\ \text{ON-state} \\ \hline \\ \hline \\ \hline \\ \hline \\ \text{ON-state} \\ \hline \\ \hline \\ \hline \\ \hline \\ \hline \\ \hline \\ \text{ON-state} \\ \hline \\ \hline \\ \hline \\ \hline \\ \hline \\ \text{ON-state} \\ \hline \\ $	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{llllllllllllllllllllllllllllllllllll$	$ \begin{array}{llllllllllllllllllllllllllllllllllll$	HIGH-level input voltage HIGH-level input voltage V _{CC} = 1.65 V to 1.95 V	HIGH-level input voltage VCC = 1.65 V to 1.95 V	

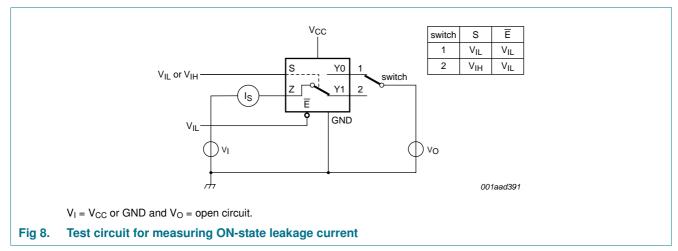
^[1] Typical values are measured at T_{amb} = 25 °C.

^[2] These typical values are measured at $V_{CC} = 3.3 \text{ V}$.

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10.1 Test circuits





10.2 ON resistance

Table 8. ON resistance

At recommended operating conditions; voltages are referenced to GND (ground 0 V); for graphs see Figure 10 to Figure 15.

Symbol	Parameter	Conditions	–40	°C to +8	5 °C	-40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	
R _{ON(peak)}	ON resistance (peak)	$V_I = GND$ to V_{CC} ; see Figure 9						
		I _{SW} = 4 mA; V _{CC} = 1.65 V to 1.95 V	-	34.0	130	-	195	Ω
		I_{SW} = 8 mA; V_{CC} = 2.3 V to 2.7 V	-	12.0	30	-	45	Ω
		$I_{SW} = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	10.4	25	-	38	Ω
		I_{SW} = 24 mA; V_{CC} = 3 V to 3.6 V	-	7.8	20	-	30	Ω
		$I_{SW} = 32 \text{ mA}$; $V_{CC} = 4.5 \text{ V}$ to 5.5 V	-	6.2	15	-	23	Ω

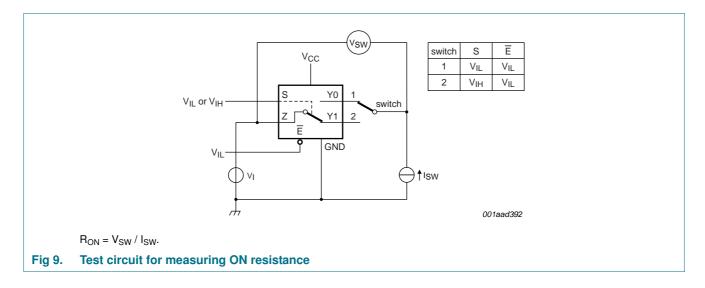
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Table 8. ON resistance ...continued
At recommended operating conditions; voltages are referenced to GND (ground 0 V); for graphs see <u>Figure 10</u> to <u>Figure 15</u>.

Symbol P	Parameter	Conditions	-40	°C to +8	85 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
R _{ON(rail)}	ON resistance (rail)	V _I = GND; see <u>Figure 9</u>			1			
	$I_{SW} = 4 \text{ mA};$ $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	8.2	18	-	27	Ω	
	$I_{SW} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	7.1	16	-	24	Ω	
	$I_{SW} = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	6.9	14	-	21	Ω	
		I_{SW} = 24 mA; V_{CC} = 3 V to 3.6 V	-	6.5	12	-	18	Ω
		I_{SW} = 32 mA; V_{CC} = 4.5 V to 5.5 V	-	5.8	10	-	15	Ω
	V _I = V _{CC} ; see <u>Figure 9</u>							
		$I_{SW} = 4 \text{ mA};$ $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	10.4	30	-	45	Ω
		$I_{SW} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	7.6	20	-	30	Ω
		$I_{SW} = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	7.0	18	-	27	Ω
		I_{SW} = 24 mA; V_{CC} = 3 V to 3.6 V	-	6.1	15	-	23	Ω
		I_{SW} = 32 mA; V_{CC} = 4.5 V to 5.5 V	-	4.9	10	-	15	Ω
$R_{ON(flat)} \\$	ON resistance	$V_I = GND$ to V_{CC}	[2]					
	(flatness)	$I_{SW} = 4 \text{ mA};$ $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	26.0	-	-	-	Ω
		$I_{SW} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	5.0	-	-	-	Ω
	$I_{SW} = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	3.5	-	-	-	Ω	
		I_{SW} = 24 mA; V_{CC} = 3 V to 3.6 V	-	2.0	-	-	-	Ω
		$I_{SW} = 32 \text{ mA}; V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	-	1.5	-	-	-	Ω

^[1] Typical values are measured at T_{amb} = 25 °C and nominal V_{CC} .

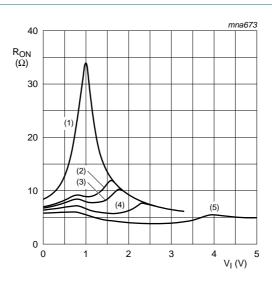
10.3 ON resistance test circuit and graphs



74LVC1G53

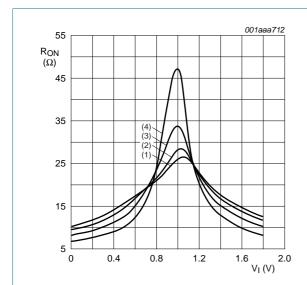
^[2] Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V_{CC} and temperature.

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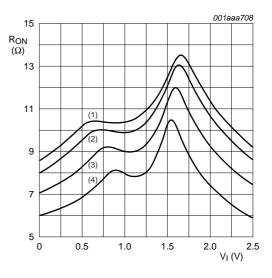
- (1) $V_{CC} = 1.8 \text{ V}.$
- (2) $V_{CC} = 2.5 \text{ V}.$
- (3) $V_{CC} = 2.7 \text{ V}.$
- (4) $V_{CC} = 3.3 \text{ V}.$
- (5) $V_{CC} = 5.0 \text{ V}.$

Fig 10. Typical ON resistance as a function of input voltage; T_{amb} = 25 °C



- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C.$
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

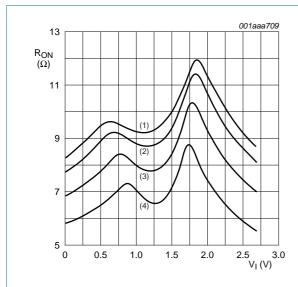
Fig 11. ON resistance as a function of input voltage; $V_{CC} = 1.8 \text{ V}$



- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

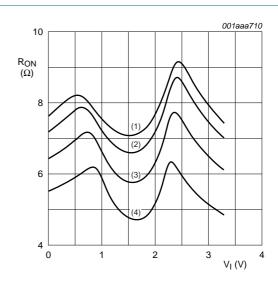
Fig 12. ON resistance as a function of input voltage; $V_{CC} = 2.5 \text{ V}$

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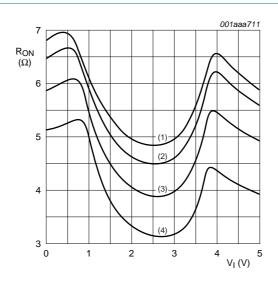
- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 13. ON resistance as a function of input voltage; $V_{CC} = 2.7 \text{ V}$



- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 14. ON resistance as a function of input voltage; $V_{CC} = 3.3 \text{ V}$



- (1) $T_{amb} = 125 \, ^{\circ}C.$
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \,^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 15. ON resistance as a function of input voltage; $V_{CC} = 5.0 \text{ V}$

2-channel analog multiplexer/demultiplexer

11. Dynamic characteristics

Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 18.

Symbol Parameter		Conditions	-40	°C to +8	5 °C	-40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	
t _{pd}	propagation delay	Z to Yn or Yn to Z; see Figure 16 [2][3	L	'	'	'	'	
		V _{CC} = 1.65 V to 1.95 V	-	-	2	-	2.5	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	1.2	-	1.5	ns
		V _{CC} = 2.7 V	-	-	1.0	-	1.25	ns
		V _{CC} = 3.0 V to 3.6 V	-	-	0.8	-	1.0	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	-	-	0.6	-	0.8	ns
t _{en}	enable time	S to Z or Yn; see Figure 17						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	2.6	6.7	10.3	2.6	12.9	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.9	4.1	6.4	1.9	8.0	ns
		V _{CC} = 2.7 V	1.9	4.0	5.5	1.8	7.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.8	3.4	5.0	1.8	6.3	ns
		V _{CC} = 4.5 V to 5.5 V	1.3	2.6	3.8	1.3	4.8	ns
		E to Z or Yn; see Figure 17						
		V _{CC} = 1.65 V to 1.95 V	1.9	4.0	7.3	1.9	9.2	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.4	2.5	4.4	1.4	5.5	ns
		V _{CC} = 2.7 V	1.1	2.6	3.9	1.1	4.9	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.2	2.2	3.8	1.2	4.8	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	1.0	1.7	2.6	1.0	3.3	ns
t _{dis}	disable time	S to Z or Yn; see Figure 17						
		V _{CC} = 1.65 V to 1.95 V	2.1	6.8	10.0	2.1	12.5	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.4	3.7	6.1	1.4	7.7	ns
		V _{CC} = 2.7 V	1.4	4.9	6.2	1.4	7.8	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.1	4.0	5.4	1.1	6.8	ns
		V _{CC} = 4.5 V to 5.5 V	1.0	2.9	3.8	1.0	4.8	ns
		E to Z or Yn; see Figure 17						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	2.3	5.6	8.6	2.3	11.0	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.2	3.2	4.8	1.2	6.0	ns
		V _{CC} = 2.7 V	1.4	4.0	5.2	1.4	6.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	2.0	3.7	5.0	2.0	6.3	ns
		V _{CC} = 4.5 V to 5.5 V	1.3	2.9	3.8	1.3	4.8	ns

^[1] Typical values are measured at T_{amb} = 25 °C and nominal V_{CC} .

^[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

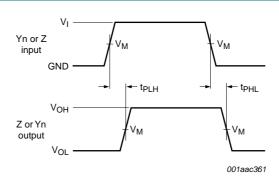
^[3] Propagation delay is the calculated RC time constant of the typical ON resistance of the switch and the specified capacitance when driven by an ideal voltage source (zero output impedance).

^[4] t_{en} is the same as t_{PZH} and t_{PZL} .

^[5] t_{dis} is the same as t_{PLZ} and t_{PHZ} .

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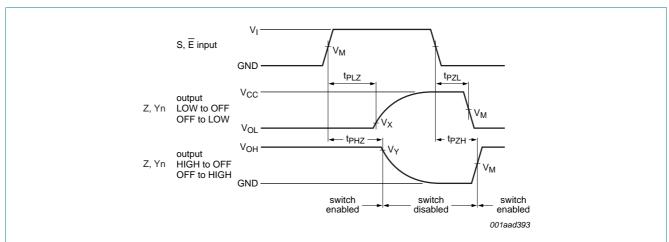
11.1 Waveforms and test circuits



Measurement points are given in Table 10.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 16. Input (Yn or Z) to output (Z or Yn) propagation delays



Measurement points are given in Table 10.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

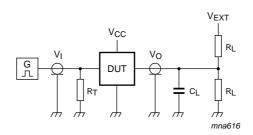
Fig 17. Enable and disable times

Table 10. Measurement points

Supply voltage	Input	Output				
V _{CC}	V _M	V _M	V _X	V _Y		
1.65 V to 2.7 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V		
2.7 V to 5.5 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	V _{OL} + 0.3 V	V _{OH} – 0.3 V		

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Test data is given in Table 11.

Definitions test circuit:

 R_T = Termination resistance (should be equal to output impedance Z_0 of the pulse generator).

C_L = Load capacitance (including jig and probe capacitance).

R_L = Load resistance.

 V_{EXT} = External voltage for measuring switching times.

Fig 18. Test circuit for measuring switching times

Table 11. Test data

Supply voltage	Input		Load	Load			
V _{CC}	VI	t _r , t _f	CL	R _L	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t_{PZL}, t_{PLZ}
1.65 V to 1.95 V	V_{CC}	≤ 2.0 ns	30 pF	1 kΩ	open	GND	$2\times V_{\text{CC}}$
2.3 V to 2.7 V	V_{CC}	≤ 2.0 ns	30 pF	500Ω	open	GND	$2 \times V_{CC}$
2.7 V	V_{CC}	≤ 2.5 ns	50 pF	500Ω	open	GND	$2 \times V_{CC}$
3 V to 3.6 V	V_{CC}	≤ 2.5 ns	50 pF	500Ω	open	GND	$2\times V_{\text{CC}}$
4.5 V to 5.5 V	V_{CC}	≤ 2.5 ns	50 pF	500 Ω	open	GND	$2 \times V_{CC}$

11.2 Additional dynamic characteristics

Table 12. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); T_{amb} = 25 °C.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
THD total harmonic distortion		f_i = 600 Hz to 20 kHz; R_L = 600 Ω ; C_L = 50 pF; V_l = 0.5 V (p-p); see Figure 19				
		V _{CC} = 1.65 V	-	0.260	-	%
		V _{CC} = 2.3 V	-	0.078	-	%
		V _{CC} = 3.0 V	-	0.078	-	%
		V _{CC} = 4.5 V	-	0.078	-	%
f _(-3dB)	-3 dB frequency response	$R_L = 50 \Omega$; $C_L = 5 pF$; see Figure 20				
		V _{CC} = 1.65 V	-	200	-	MHz
		V _{CC} = 2.3 V	-	300	-	MHz
		V _{CC} = 3.0 V	-	300	-	MHz
		$V_{CC} = 4.5 \text{ V}$	-	300	-	MHz

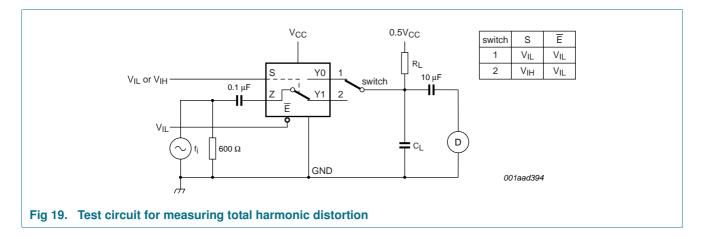
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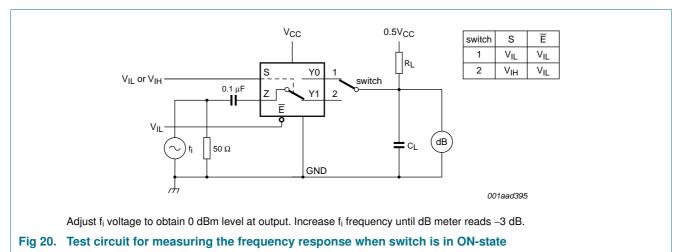
Table 12. Additional dynamic characteristics ... continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); T_{amb} = 25 °C.

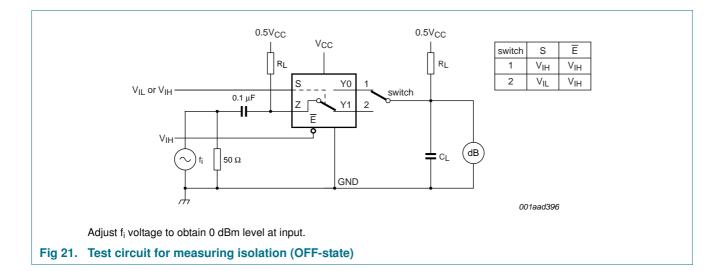
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
α_{iso}	isolation (OFF-state)	$R_L = 50 \Omega$; $C_L = 5 pF$; $f_i = 10 MHz$; see Figure 21				
		V _{CC} = 1.65 V	-	-42	-	dB
		V _{CC} = 2.3 V	-	-42	-	dB
		V _{CC} = 3.0 V	-	-40	-	dB
		V _{CC} = 4.5 V	-	-40	-	dB
Q _{inj}	charge injection	C_L = 0.1 nF; V_{gen} = 0 V; R_{gen} = 0 Ω ; f_i = 1 MHz; R_L = 1 M Ω ; see <u>Figure 22</u>				
		V _{CC} = 1.8 V	-	3.3	-	рС
		$V_{CC} = 2.5 \text{ V}$	-	4.1	-	рС
		$V_{CC} = 3.3 \text{ V}$	-	5.0	-	рС
		V _{CC} = 4.5 V	-	6.4	-	рC
		V _{CC} = 5.5 V	-	7.5	-	рС

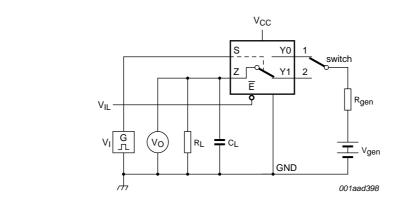
11.3 Test circuits



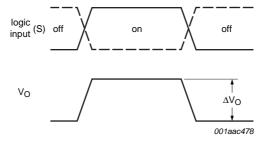


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a. Test circuit



b. Input and output pulse definitions

 $Q_{inj} = \Delta V_O \times C_L.$

 ΔV_{O} = output voltage variation.

R_{gen} = generator resistance.

V_{gen} = generator voltage.

Fig 22. Test circuit for measuring charge injection

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12. Package outline

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm SOT505-2

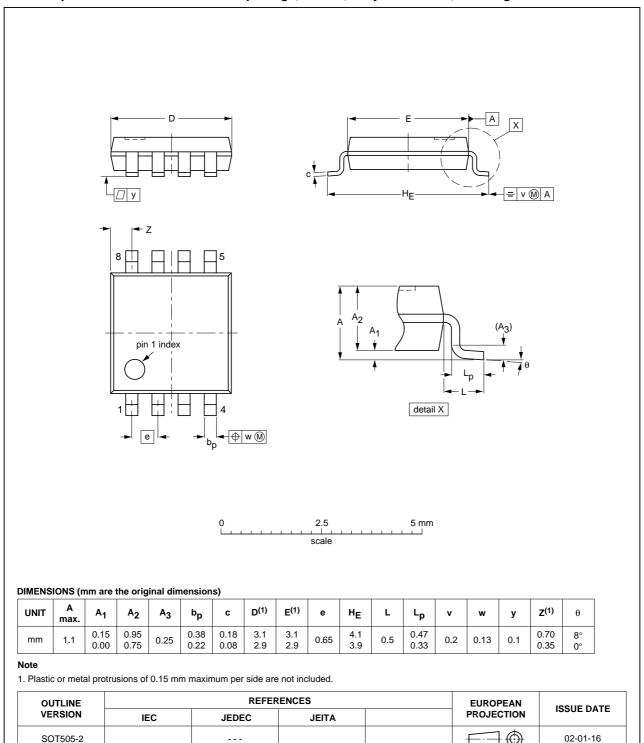


Fig 23. Package outline SOT505-2 (TSSOP8)

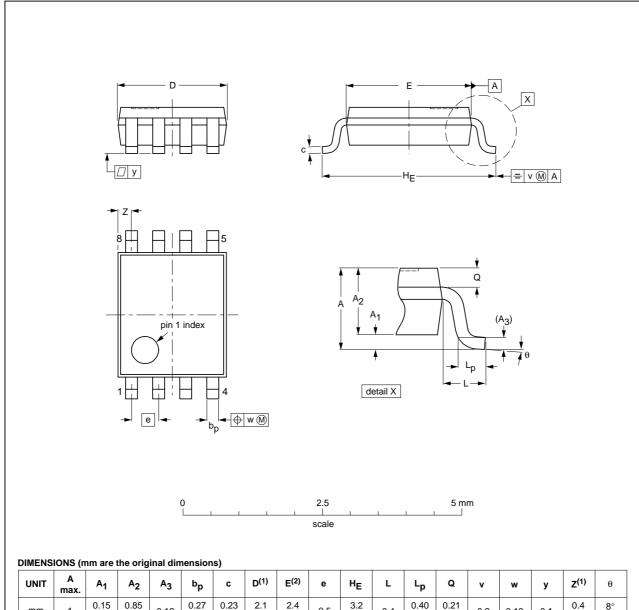
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VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm

SOT765-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1	0.15 0.00	0.85 0.60	0.12	0.27 0.17	0.23 0.08	2.1 1.9	2.4 2.2	0.5	3.2 3.0	0.4	0.40 0.15	0.21 0.19	0.2	0.13	0.1	0.4 0.1	8° 0°

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT765-1		MO-187				02-06-07

Fig 24. Package outline SOT765-1 (VSSOP8)

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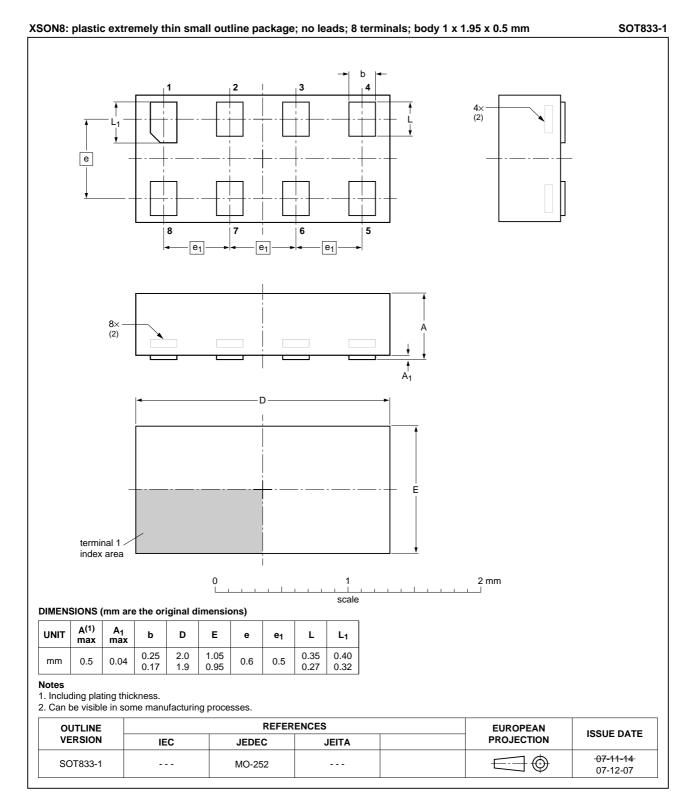


Fig 25. Package outline SOT833-1 (XSON8)

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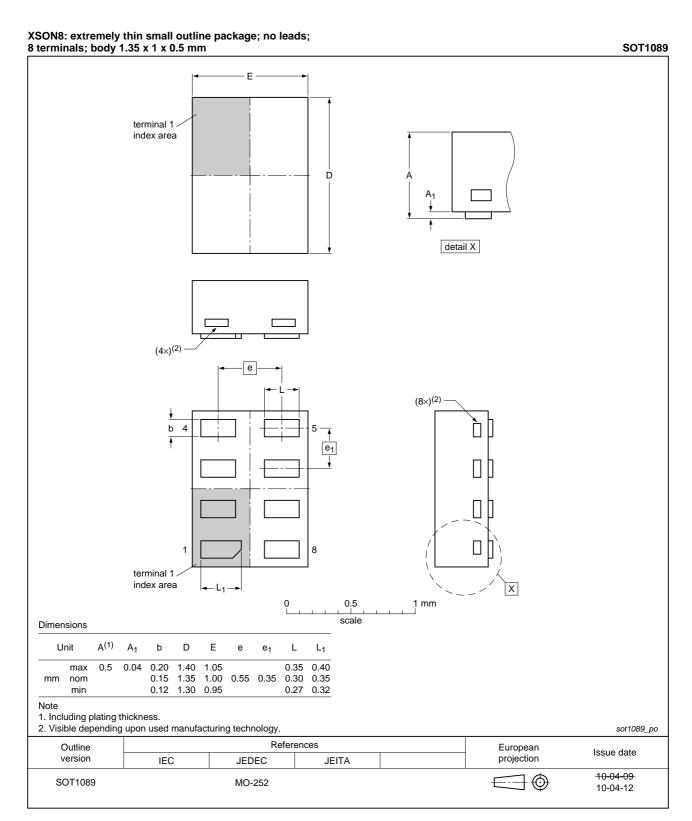


Fig 26. Package outline SOT1089 (XSON8)

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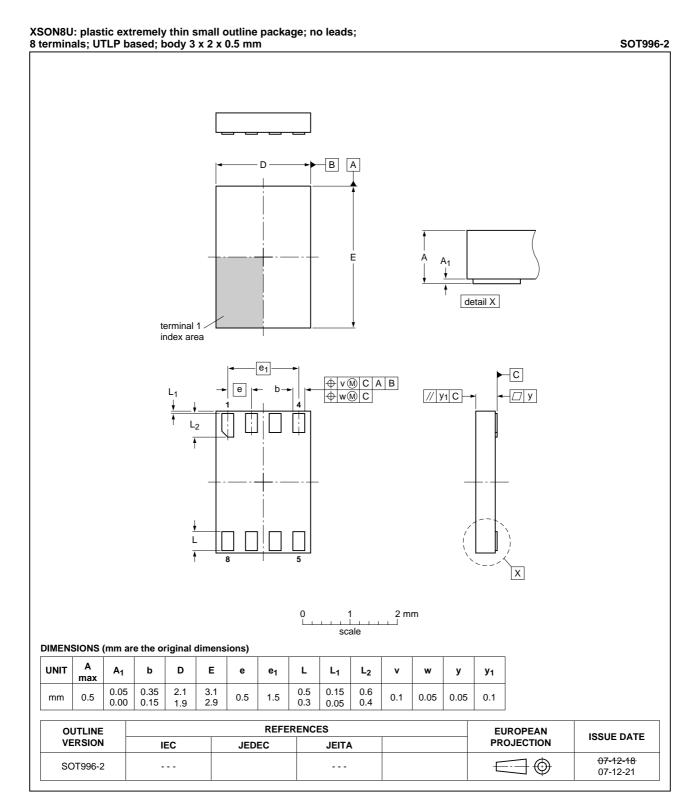


Fig 27. Package outline SOT996-2 (XSON8U)

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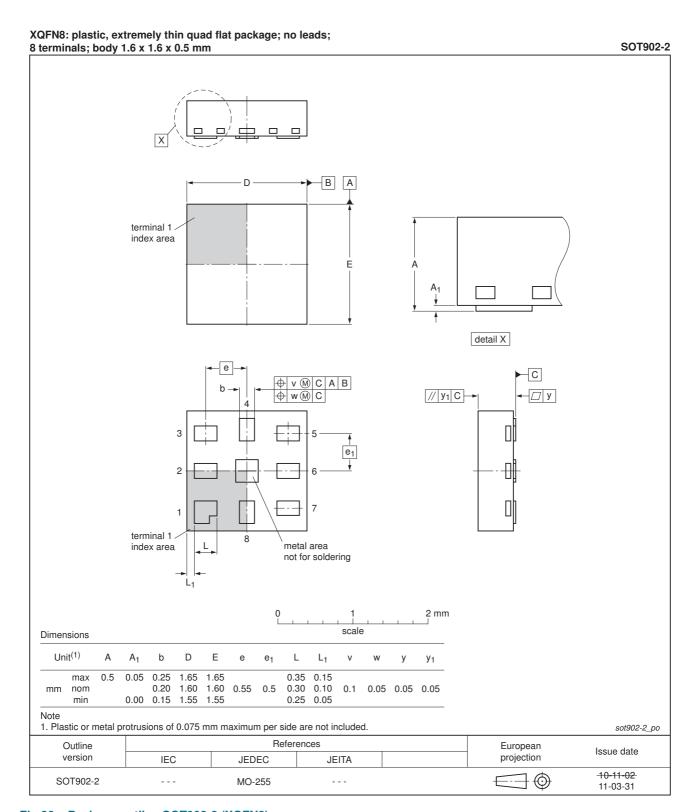


Fig 28. Package outline SOT902-2 (XQFN8)

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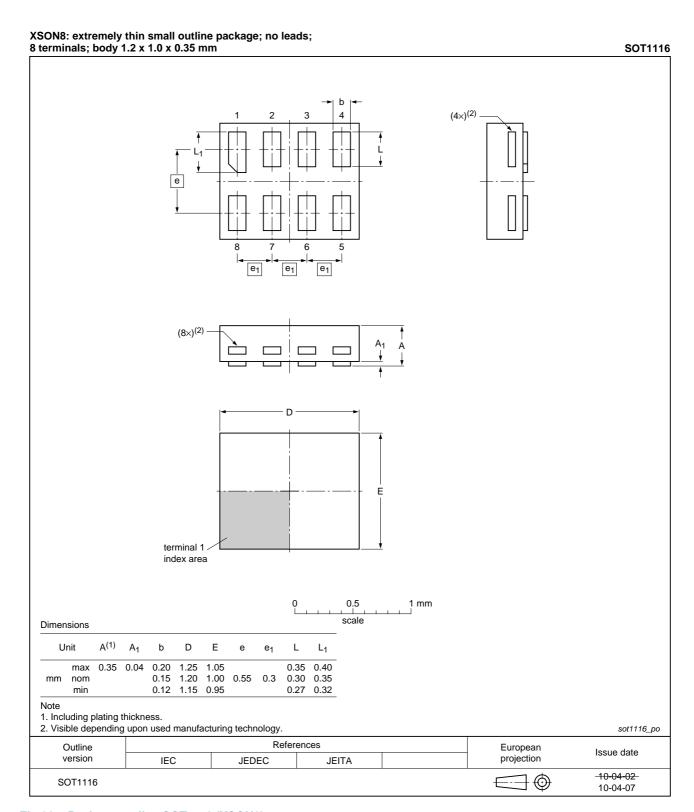


Fig 29. Package outline SOT1116 (XSON8)

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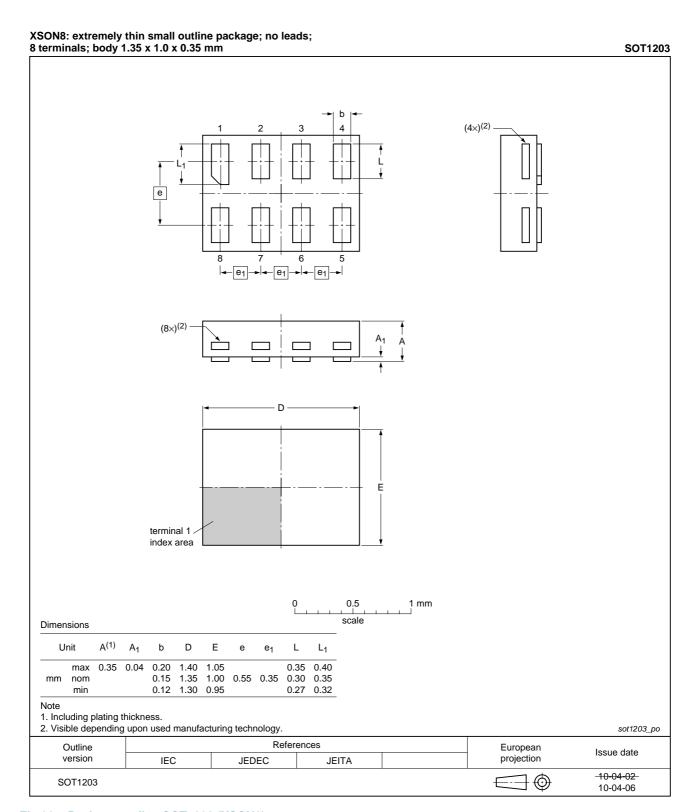


Fig 30. Package outline SOT1203 (XSON8)

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13. Abbreviations

Table 13. Abbreviations

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
TTL	Transistor-Transistor Logic
НВМ	Human Body Model
ESD	ElectroStatic Discharge
MM	Machine Model
CDM	Charged Device Model
DUT	Device Under Test

14. Revision history

Table 14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC1G53 v.8	20120622	Product data sheet	-	74LVC1G53 v.7
Modifications:	 For type nun 	nber 74LVC1G53GM the SOT	code has changed to	o SOT902-2.
74LVC1G53 v.7	20111206	Product data sheet	-	74LVC1G53 v.6
Modifications:	 Legal pages 	updated.		
74LVC1G53 v.6	20100621	Product data sheet	-	74LVC1G53 v.5
74LVC1G53 v.5	20080611	Product data sheet	-	74LVC1G53 v.4
74LVC1G53 v.4	20080303	Product data sheet	-	74LVC1G53 v.3
74LVC1G53 v.3	20070829	Product data sheet	-	74LVC1G53 v.2
74LVC1G53 v.2	20060410	Product data sheet	-	74LVC1G53 v.1
74LVC1G53 v.1	20060110	Product data sheet	-	-

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15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design
- [2] The term 'short data sheet' is explained in section "Definitions"
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